

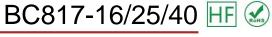


Product data sheet

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Semiconductor Compiance



BASE
EMITTER
COLLECTOR

GC H!&' ``

TRANSISTOR (NPN)

:95 HIF9G

- For general AF applications
- High collector current
- High current gain
- Low collector-emitter saturation voltage
- Complementary types: BC807 (PNP)

7 @ GG= = 5 H=C B C: hFE'ft/L

FUb_'	67,%+!% [*]	67,%+!&) [`]	67,%+!(\$ [`]
FUb[Y	%\$\$!&) \$`	%\$!(\$\$ ⁻	&) \$!* \$\$`
A Uf_]b[`	*5 ⁻	*6`	*7`

MAXIMUM RATINGS (T_a=25℃ unless otherwise noted)

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage	50	V
VCEO	Collector-Emitter Voltage	45	V
V _{EBO}	Emitter-Base Voltage	5	V
lc	Collector Current	500	mA
Pc	Collector Power Dissipation	300	mW
R _{oja}	Thermal Resistance From Junction To Ambient	417	°C/W
T _J ,T _{stg}	Operation Junction and Storage Temperature Range	-55~+150	°C

'9 @97 HF=75 @7<5F57 H9F=GH=7 G`fH⊪1&)°C`ib`Ygg`ch\Yfk]gY`gdYW]QYXŁ

····· DUFUa YhYf	'GnaVc`'	^{···} HYghi WcbX]h]cbg [·]	[.] Ain	Тур	· Aax	Unit
7c``YWfcf!VUgY'VfYU_Xckb'jc`HU[Y'	V _{CBO}	I _C = 10μΑ, I _E =0	50			V
7c``YWMcf!Ya]HhYf`VfYU_Xckb`jc`HU[Y`	V _{CEO}	I _C = 10mA, I _B =0	45			V
9a]HhYf!VUgY'VfYU_Xckb'jc`HU[Y'	V _{EBO}	I _E = 1μΑ, I _C =0	5			V
7c``YWrcf'WiHcZZWiffYbh	I _{CBO}	V _{CB} = 45 V , I _E =0			0.1	μA
9a]lhhff WillcZZWiffYbh	I _{EBO}	V_{EB} = 4V, I _C =0			0.1	μA
	h _{FE(1)}	V _{CE} = 1V, I _C = 100mA	100		600	
87'WiffYbh[U]b	h _{FE(2)}	V _{CE} = 1V, I _C = 500mA	40			
7c``YWrcf!Ya]HhYf`gUhifUh]cb`jc`HU[Y`	V _{CE} (sat)	I _C = 500mA, I _B = 50mA			0.7	V
6UgY!Ya]HhYf`gUhifUh]cb`jc`HU[Y`	V _{BE} (sat)	I _C = 500mA, I _B = 50mA			1.2	V
6UgY!Ya]HHYfijc`HU[Y	V _{BE}	V _{CE} = 1 V, I _C = 500mA			1.2	V
7 c``YWWYf`WUUUWIJUbWY'	C _{ob}	V _{CB} =10V ,f=1MHz		10		pF
HiUbg]h]cbʻZiYei YbWm	f _T	V _{CE} = 5 V, I _C = 10mA f=100MHz	100			MHz

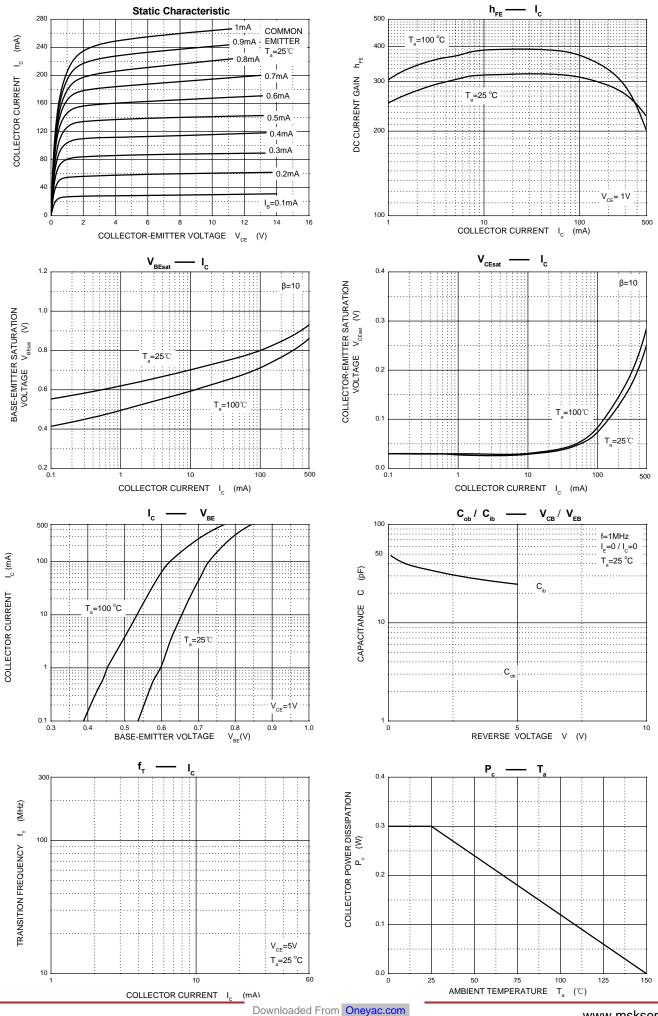


BC817-16/25/40 HF RoHS

Semiconductor

Compiance

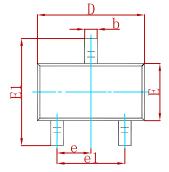
Typical Characteristics

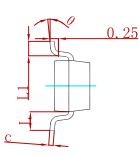


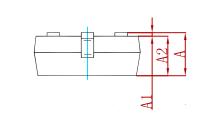


BC817-16/25/40 HF 🐼 Semiconductor Compiance

PACKAGE MECHANICAL DATA

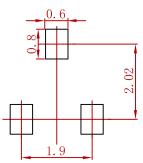






Sumbal	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

Suggested Pad Layout



Note:

Controlling dimension:in millimeters.
General tolerance:± 0.05mm.
The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
BC817-16/25/40	SOT-23	3000



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